



# **SPECIFICATION**

Customer: VIVO		
		Descipt
Item:	Crystal Unit	Receipt
Туре:	NX2520SG	
Nominal Frequency:	26 MHz	
Customer's Spec. No.:		
NDK Spec. No.:	EXS00A-CS05258	

	Revision Record							
Rev.	Date	Items	Contents	Approved	Checked	Drawn		
	11.Jul.2017	Issue		I. Miyahara		Y. Takaki		

1. Customer Specifications Number : ---

2. NDK Specification Number : EXS00A-CS05258

3. Type : NX2520SG

### 4. Electrical Characteristics

	_	0.41		Electri	cal Spe	C.	
	Parameters	SYM.	Min	TYP	MAX	Units	Notes
1	Nominal Frequency	fnom		26	1	MHz	
2	Overtone order	-	Fu	ndamen	ıtal	-	
3	Frequency tolerance	•	-10	-	+10	ppm	at +25 <b>→</b> C
4	Frequency versus temperature characteristics	-	-10	-	+10	ppm	at -25~+85→C The reference temperature shall be+25°C
5	Equivalent Resistance	-	-	-	30	Ω	-
6	Load capacitance	$C_L$	-	7	-	pF	IEC ▲-Network
7	Level of drive	DL	-	100	100	μW	-
8	Temperature coefficient						
8-1	Third-order curve fitting coefficient	-	8.7	-	11	x 10 <sup>-5</sup> ppm/°C <sup>3</sup>	Fitting equation is defined by formula below and four kinds of temperature coefficient parameters, which are calculated from
8-2	Second-order curve fitting coefficient	-	-12	-	-5	x 10 <sup>-4</sup> ppm/°C <sup>2</sup>	operating temperature under per 2 →C steps measurement data.
8-3	First-order curve fitting coefficient	-	-0.35	-	-0.18	ppm/°C	****
9	Frequency perturbation	ı	-0.5	-	+0.5	ppm	*Measurement condition: Peak-to-peak deviation from the frequency versus temperature curve fit 3th order. Minimum of 1 frequency reading every 2°C over operating temperature range.
10	Temperature Hysteresis						-
10-1	Full cycle temperature hysteresis	-	-0.5	-	+0.5	ppm	Difference in freq. measurement at any temperature when undergoing a thermal cycle over the entire operation temperature range from -40 °C to 85 °C.
10-2	Small cycle temperature hysteresis	1	-0.05	-	+0.05	ppm	Difference in freq. measurement at any temperature when undergoing a thermal cycle of a temperature range of 5 °C for each 1 °C test.  *Measurement condition: Frequency measured for every 5 °C / Temperature drift rate is 1 °C / min.
11	Frequency slope error over Temperature	ı	-0.05	-	+0.05	ppm	at -10 to +60 →C Freq. slope error between measured S curve (fL) data and 3rd order curve fitting data over operation temperature under per 2 °C test.
	•	ı	-0.1	-	+0.1	ppm	at -30 to +85 →C Same as above.
	Turning Sensitivity	-	-10%		+10%	ppm/pF	at CL = 7pF
_	Drive level dependency (Drive leve	el: 1nW	to 100u\	N)	ī	1	-
_	DLD2	-	-	-	2.5	Ω	-
-	DLDH2	-	-	-	1.5	Ω	-
	FDLD	-	-	-	2	ppm	-
13-4	FDLDH	-	-	-	0.7	ppm	-
	G sensitivity	-	-	-	2	x 10 <sup>-9</sup> /G	Gamma vector of all three axes from 30Hz to 1.5kHz
	Aging			r	Т		-
	Aging (1 <sup>st</sup> year)	-	-1	-	+1	ppm	-
15-2	Aging (2 <sup>nd</sup> years)	-	-1.5	-	+1.5	ppm	<u> -</u>

15-3	Aging (5 years)	-	-2.5	-	+2.5	ppm	-
15-4	Aging (10 years)	-	-5	•	+5	ppm	-
16	Spurious mode resistance	-	500	•	-	Ω	F nom within +/-1MHz
17	Insulation resistance	ı	500	,	-	МΩ	Terminal to terminal insulation resistance also terminal to cover insulation resistance when DC100V ±15V is applied.
18	Operable temperature range	-	-30	-	+105	°C	-
19	Storage temperature range	-	-40	•	+125	°C	-
20	Air-tightness	-	-	•	1.1×10 <sup>-9</sup>	Pa m <sup>3</sup> /s	Helium leak detector
21	MSL	-	-	-	-	-	MSL 1
22	ESD(HBM)	-	-	•	1000	V	Guarantee voltage
23	ESD(MM)	-	-	-	200	V	Guarantee voltage

#### Thermistor Characteristics

	Developed	SYM.		Electri	cal Spec	).	Notes
	Parameters		Min	TYP	MAX	Units	Notes
1	Size	- 0.6 x 0.3		x 0.3 x	0.3	mm	-
2	Room temperature resistance	-	-1%	100	+1%	kΩ	at +25 <b>→</b> C
3	B const	-	-1%	4250	+1%	K	Evaluated from 25°C to 50°C
4	Rated power (at 25→C)	-	-	-	100	mW	

#### 5. Examination results document

Since a performance is guaranteed, an examination results document does not submit.

6. Application drawing

6.1. Dimension Drawing : EXD14B-00482

6.2. Taping and Reel figure : EXK17B-00318, EXK17B-00411

6.3. Holder Marking : EXH11B-00319 6.4. Packing Label : EXK17B-00422 6.5. Reliability assurance Item : EXS30B-01030

#### 7. Notice

- 7.1 Order items are manufactured according to specification. As to conditions, which are not indicated in this specification and unpredictable such as applied condition and oscillation margin, please check them beforehand.
- 7.2 Unless we receive request for modification within 3 weeks from the issue date of this NDK specification sheet, we will supply products according to this specification. Also, if you'd like to modify specification of order, which has been placed with delivery request within 3 weeks from the issue data of this specification sheet, we would like to discuss with you separately.
- 7.3 In no event shall the company be liable for any product failure resulting from an inappropriate handling or operation of the product beyond the scope of its guarantee.
- 7.4 Where any change to the process condition is made due to the change(s) in the production line, inform personnel of the specifications.
- 7.5 Should this specification data give rise to any disputes relating to any intellectual property rights or any other rights of a third person, the company shall not indemnify anyone for any damage.

- Their disclosure must not be construed as the grant of a license to use any of the intellectual property rights owned by the company.
- 7.6 If you intend to use products listed on this specification for applications that may result in loss of life or assets (controls relating to safety, medical equipment, aeronautical equipment, space equipment, etc.), please do not fail to advise us of your intention beforehand.
- 7.7 In the company's production process whatever amount of ozone depleting substances (ODS) as specified in the Montreal protocol is not used.
- 7.8 Information contained in this specification must not be quoted, reproduced or used for other purposes including processing either in part or in full without obtaining prior approval from the company.
- 7.9 Crystal units will be damaged by ultrasonic welding process due to resonance of crystal wafer itself. NDK does not recommend using ultrasonic welding. If Ultra Sonic welding used, NDK strongly recommend verifying crystal unit damage by ultrasonic weld.
- 7.10 The appearance color has a different case by purchasing it more than 2 suppliers of the component, but characteristic and reliability are guaranteed.
- 7.11 In case of the product long time keep at high temperature and humidity, may affect product characteristic (solder ability) and a packing condition.

  Please keep at storage condition of temperature +5→C ~+35→C, humidity ~85%RH.

#### 8. Prohibited items

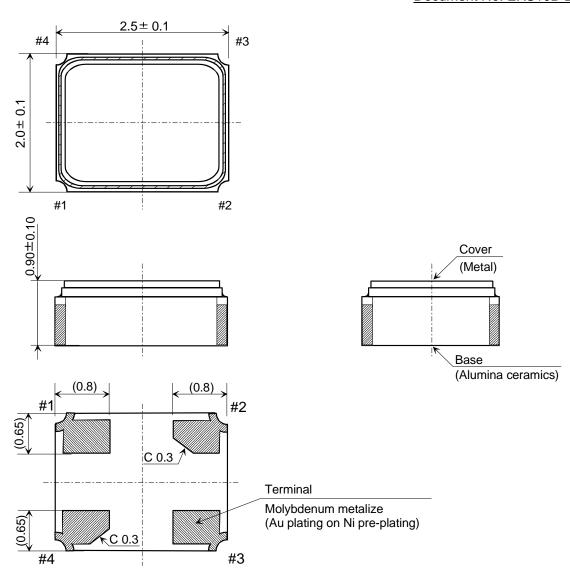
Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

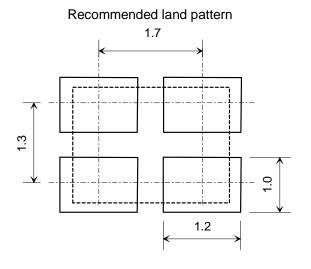
(1) Reflow soldering heat resistance

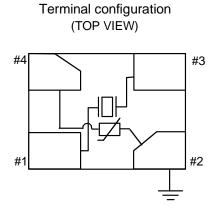
Peak temperature: 265→C, 10 sec Heating: 230→C or higher, 40 sec Preheating: 150→C to 180→C, 120 sec Reflow passage times: three times

(2) Manual soldering heat resistance

Pressing a soldering iron of 400→C on the terminal electrode for four seconds (twice).

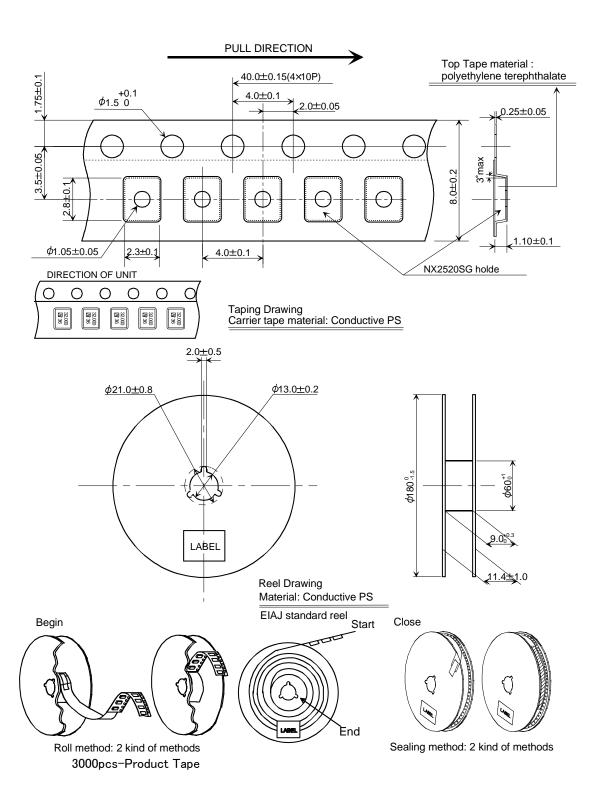




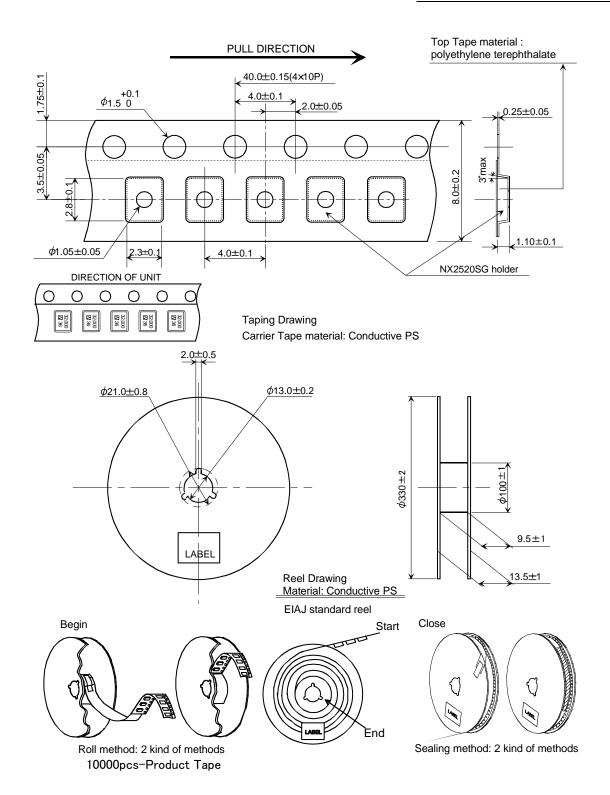


Terminal	Function
#1, #3	XTAL IN-OUT
#4	THERMISTOR IN
#2	THERMISTOR OUT
#2	GND (Connected with cover)

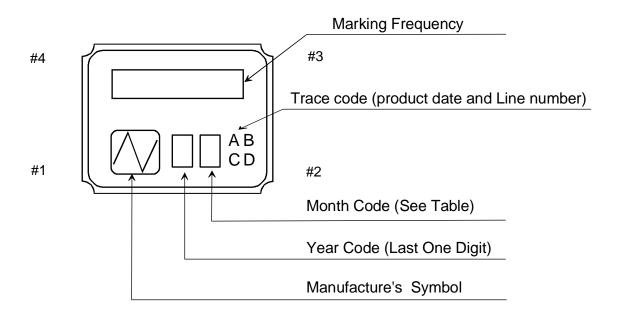
	Dat	e of Revise	Charge	Approved Reason		n				
В	20	. Apr. 2011	M. Wada	Y. Sakuma Changed to te		ed to term	terminal function table			
		Date	Name	Third Angle Projection		То	lerance	Sca	ale	
Drav	wn	17. Dec. 2010	T. Asamizu	Dimension: mm					-	
Des	signed	17. Dec. 2010	T. Asamizu	Title		ı	Drawing No.		Rev.	
Che	ecked	17. Dec. 2010	I. Miyahara	NX2520SG Dimension Drawing			EXD14B-00482		D	
App	roved	17. Dec. 2010	K. Ueki			ng	EXUI4D-	В		



	Dat	te of Revise	Charge	Approved	Reason			
Α	7	Oct. 2016	H. Ohkubo	H. Murakoshi Addition of roll method and sea		ling method.		
		Date	Name	Third Angle Proje	ection	Tolerance	Sc	ale
Draw	wn	06. Jan. 2011	T.Asamizu	Dimension: m	Dimension: mm			
Desi	signed	06. Jan. 2011	T.Asamizu	Title		Drawing No.		Rev.
Che	ecked	06. Jan. 2011	I.Miyahara	NX2520SG		EXK17B-	.00218	۸
App	roved	06. Jan. 2011	K.Ueki	Taping and Reel Spec.		LXK17D-	_ ^	



	Dat	te of Revise	Charge	Approved Reason		1			
Α	7	Oct. 2016	H. Ohkubo	H. Murakoshi Addition of roll n		of roll method	Il method and sealing method.		
		Date	Name	Third Angle Projection T		Toleranc	Tolerance Se		ale
Dra	wn	2 Sep. 2016	H. Ohkubo	Dimension: mm					/ <b>-</b>
Des	signed	2 Sep. 2016	H. Ohkubo	Title		Drawing	g No.		Rev.
Che	ecked			NX2520SG		EV	'K17D	-00/11	Α
App	oroved	2 Sep. 2016	H. Ohkubo	Taping and Reel Spec.		ec.	EXK17B-00411		



### **NOTE**

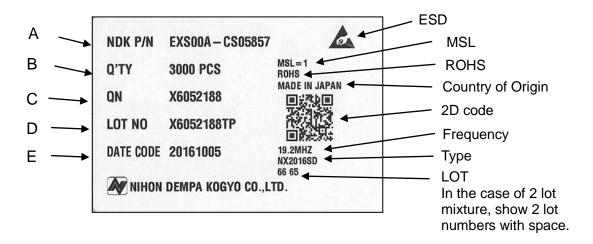
### 1. Month Code Table

Month	1	2	3	4	5	6	7	8	9	10	11	12
	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Month Code	1	2	3	4	5	6	7	8	9	х	Υ	Z

<sup>\*</sup>Marking digits are not include a decimal point and dot mark.

	Dat	e of Revise	Charge	Approved Reason					
Α	10	. Jul. 2008	T.Asamizu	K.Kubota Delete application		tion period.			
		Date	Name	Third Angle Pro	jection	Tolerance		Sca	ale
Drav	wn	14. Feb. 2006	T.Asamizu	Dimension:mm				/	1
Des	signed	14. Feb. 2006	T.Asamizu	Title			Drawing No.		Rev.
Che	ecked	14. Feb. 2006	I.Miyahara	Crystal Halder Marking			EVIIIAD	00240	۸
App	oroved	14. Feb. 2006	K.Okamoto	Crystal Holder Marking		EXH11B-00319		А	

### LABEL SIZE: 76-50mm



No.	Marking Item	Marking Contents					
Α	NDK P/N	NDK Part Number					
В	Q'TY	Total quantity					
С	QN	Serial Number					
D	LOT NO.	Serial Number + TP					
Е	DATA CODE	Date of making label					

	改訂日/ Date of Revise 担当/ Charg		担当/ Charge	承認/ Approved	理由/ Reason				
		Date	Name	三角法/ Third Angle Projection		公	差/ Tolerance	尺度/ Scale	
Drawn		27. Mar. 2017	Y. Takaki	<del>単位:mm</del>					
Designed		27. Mar. 2017	Y. Takaki	名称/Title			図番/ Drawing No.		改訂/ Rev.
Checked				De ekiner	اماما	EVV47D		00422	
Approved		27. Mar. 2017	I. Miyahara	Packing Label		EXK17B-00422			

## Reliability assurance item (1/1)

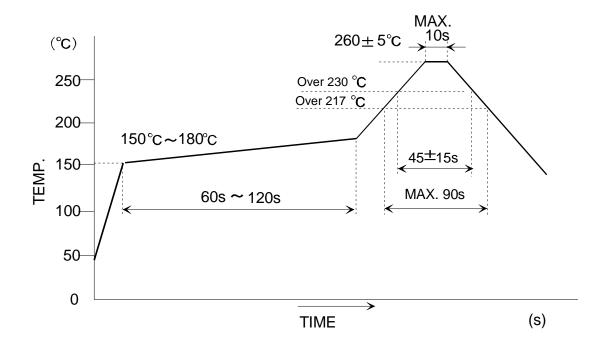
(page: 1/2)

No.	Test Item	Test Methods		
1	High temperature	Temperature: +125 →C Test time: 1000 Hr.		
2	Cold resistance	Temperature: −40 →C Test time: 1000 Hr.		
3	Humidity	at +85 →C with 80 to 85 % R	A, B	
4	Thermal shock (TS)	-40±3→C / +125±3→C 300Cycle/1H per cyc.	A, B	
5	Thermal cycle(TC)	-40±3→C / +125±3→C 300Cycle/1H per cyc.		A, B
6	Vibration	Frequency Range Amplitude or Acceleration Test time	10 to 2000Hz 1.55 mm or 100m/s <sup>2</sup> 3 axis each 2H.	A, B
7	Bending	Test board Test time	100mm x 40mm x 1.6mm bending 5mm (1mm/s) , Time 5 sec	A, B
8	Shock 1	Shock Height Drop times	Device are put on the weight of 200 g onto concrete  1.8 m  3 times for each six side derection and four corner. Totally 30 drops.	A, B
9	Shock 2	Shock Height Drop times	Device are put on the weight of 200g and concrete.  1.0 m  300 drops . 12drops/ min.	А, В
10	Blank Shear Test	Pull the center of crystal blank vertically.		
11	Reflow resistance	Temperature cycle as shown	A, B	
12	Air Tightness	Helium leak test.		
13	瞬停 Test	Devices are shocked to half six mutually perpendicular ax	D	

Specification code	Specification		
А			
В	Thermistor resistance: ≒R/R ↑ 5%		
С	No leak		
D	No 瞬停		

### Reliability assurance item (2/2)

Recommended reflow profile



A: 150 to 180 →C ( 90 ← 30 sec. ) B: 230→C min. ( 30 sec. max.)

C: Peak temperature. 260→C ← 5 →C (10sec. max.)

D: 217 → C Min. (90 sec. max.)